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ORCA-HOO

sCMOS camera C17440-20U



New options for routine models

A new routine model equipped with a back-illuminated sCMOS sensor has been added to the lineup. This model boasts high performance and is suitable for advanced microscope observation.

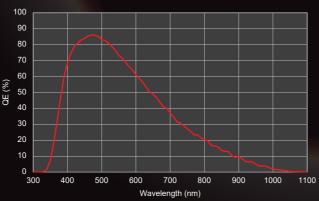




High QE

By adopting a back-illuminated sensor, we have achieved a high quantum efficiency of 86 % (Peak QE). This contributes to the improvement of the S/N ratio.

Spectral response



Low readout noise

ORCA-Halo offers a wide range of settings to adjust readout noise according to the sample.

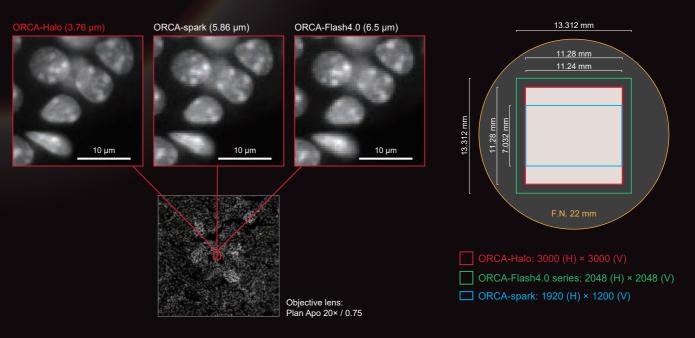
(For details, please refer to the specifications on page 4.)

Typical readout noise

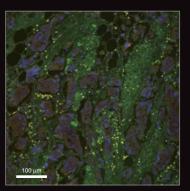
Camara setting	RMS [electrons]	Median [electrons]
16 bit standard / Analog gain ×1*1	1.6	1.2
16 bit standard / Analog gain ×8	1.3	0.9

High resolution & wide field of view

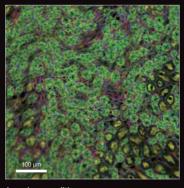
ORCA-Halo features a sensor with a pixel size of 3.76 µm, which is one of the smallest pixel sizes among our sCMOS cameras. Additionally, it has a high resolution of 3000 pixels × 3000 pixels, allowing it to capture wider and clearer images compared to ORCA-spark.



Measurement Examples (Overlay images)



Imaging condition		
Sample	Mammary gland	
Objective lens	Plan Apo 20× / 0.75	
Analog gain	×1	
Exposure time	COL1 Alexa 488: 10 ms CK Alexa 594: 10 ms Iba1 Alexa 647: 10 ms	



Imaging condition		
Sample	FluoCellsTM Prepared slide #3 mouse kidney section	
Objective lens	Plan Apo 20× / 0.75	
Analog gain	×1	
Exposure time	DAPI: 10 ms AF 488 WGA: 10 ms AF 568 phalloidin: 100 ms	



Imaging condition Autofluorescence of loofah pollen Objective lens Plan Apo 20× / 0.75 B: 10 ms

Flexibility through Combination with Relay Lenses

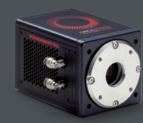
By combining the ORCA-Halo with a demagnifying relay lens, it is possible to expand the field of view.

In the ORCA-Halo: magnification of various relay lenses, pixel size at the primary image plane, and corresponding field of view

Relay lens (magnification)	Pixel Size (µm)	Field of view size (mm) *1	Field of view size (mm) *2
1.00	3.76 × 3.76	11.28 × 11.28	15.95
0.70	5.37 × 5.37	16.11 × 16.11	22.79
0.63	5.97 × 5.97	17.90 × 17.90	25.32
0.60	6.27 × 6.27	18.80 × 18.80	26.59
0.50	7.52 × 7.52	22.56 × 22.56	31.90



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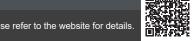


Forced-air and water cooling functions, low dark current

ORCA-Halo is equipped with both forced-air cooling and water cooling, allowing you to choose the cooling method according to your needs. Additionally, its low dark current enables the acquisition of high S/N ratio images even during long exposure fluorescence imaging.

Equipped with Lightsheet Readout Mode (patented)

Lightsheet Readout Mode is a readout method for sCMOS cameras that improves the S/N ratio of Lightsheet microscopes. In beam scanning type Lightsheet microscopes, synchronizing the readout timing with the movement of the excitation light reduces the impact of scattered light, enabling the acquisition of high S/N ratio images.

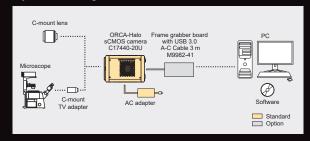




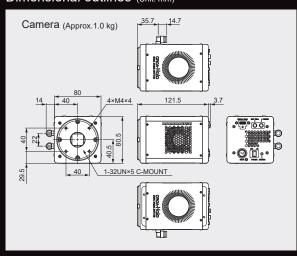
Specifications

	Product number		C17440-20U		
Imaging device Effective number of pixels			Scientific CMOS sensor		
Pixel size			00 (H) × 3000 (V)		
Effective area			'6 μm × 3.76 μm 280 mm × 11.280 mr	n	
				"	
Quantum efficiency (Typ.)			% (peak QE)		
Analog gain	Analas sain v		, ×8		
Full Well	Analog gain ×		100 electrons		
	ard / Analog g		000 electrons		
	ard / Analog g		50 electrons	ala atuana (na atian)	
	Analog gain ×		electrons (rms), 3.4		
	ard / Analog g		electrons (rms), 1.2		
· / - \	ard / Analog g		1.3 electrons (rms), 0.9 electrons (median)		
	Analog gain ×		7.4 electrons (rms), 7.2 electrons (median)		
	ard / Analog g		2.6 electrons (rms), 2.4 electrons (median) 1.6 electrons (rms), 1.2 electrons (median)		
	ard / Analog g				
Dynamic 16 hit stone	Analog gain ×		000:1 (rms), 14 000:		
range (Typ.)*2	ard / Analog g		000:1 (rms), 13 000:		
16 bit stand	ard / Analog g		00:1 (rms), 2200:1 (m	ledian)	
Linearity error		0.2		at was days	
Sensor mode		Are	ea readout / Lightshe		
Cooling method (Peltier cool			Sensor temperature	Dark current (Typ.)	
Forced-air cooled (Ambient t			+10 °C	0.03 electrons/pixels/s	
Water cooled (Ambient temperatu	re, Water temper	rature: +25 °C)	+10 °C	0.03 electrons/pixels/s	
Readout speed					
16 bit	18.2 fra	me/s			
12 bit	24.3 fra	me/s			
Area readout					
	16 bit: 1	70.7 µs to 10	s		
Exposure time		1.3 µs to 10 s			
Readout mode			al binning (2×2, 4×4) /	Sub-array	
Lightsheet readout	- un resc	Digite	(E Z, T T) /		
	16 hit: 1	70 7 us to 96	0 ms		
Exposure time		6 bit: 170.7 µs to 960 ms 2 bit: 41.3 µs to 960 ms			
		•			
Line interval (1 H) changeab	le	12.19 µs to 320 µs 5.167 µs to 320 µs			
					
Readout direction	Bidirecti	rd readout / Backward readout / ctional readout / Reverse bidirectional readout			
Digital output					
	put 16 bit, 12 bit USB 3.1 Gen1				
Interface		2 bit			
Interface	USB 3.1	2 bit 1 Gen1			
Interface Lens mount	USB 3.1 C-moun	2 bit 1 Gen1 it	ion / Start trigger / Bu	ırst	
Interface Lens mount Pulse mod	USB 3.1 C-moun e Internal	2 bit 1 Gen1 it Synchronizat	ion / Start trigger / Bu	ırst	
Interface Lens mount Pulse mod Master pulse Pulse inter	USB 3.1 C-moun e Internal val 5 µs to	2 bit 1 Gen1 it Synchronizat 10 s (1 µs ste		ırst	
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System configuration



Dimensional outlines (Unit: mm)



Readout speed (frame/s)

Area readout mode (1×1)

Number of p	ixels (pixels)	Readout speed (frame/s)	
X	Y	16 bit	12 bit
3000	3000	18.2	24.3
3000	2304	23.7	31.6
3000	2048	26.6	35.5
3000	1024	53.2	71.1
3000	512	106	142
3000	256	212	283
3000	128	423	563
3000	8	1780	4840
3000	4	1950	5380

Options

Product number	Product name
A17657-01	Base plate for ORCA-Halo
A12106-05	External trigger cable SMA-BNC 5 m
A12107-05	External trigger cable SMA-SMA 5 m
C3142-11	Water circulator
A10788-04	Hose set without joint

*1 Factory settings *2 Calculated from the ratio of the full well capacity and readout noise

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